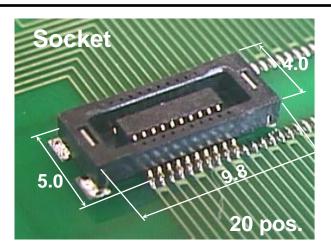
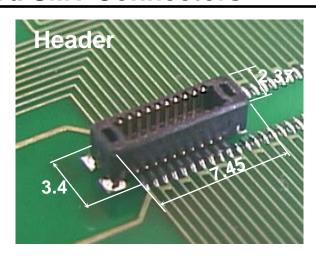


DF29 Series

0.5mm pitch, 2.5mm Stacking Height **Board to Board SMT Connectors**



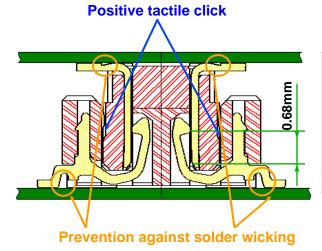


Features

- 1. Space Saving Design Socket: approx. 33% reduced, header: approx. 19% reduced in occupied mounting area compared to Hirose's conventional type DF16
- 2. Long Effective Mating Length: 0.68mm
- 3. Tactile Click & Secure Retention Force for mating
- 4. Contact Buckling Prevented Mating Design
- 5. Varieties: 2.5mm stacking height 20, 40 pos. available 2.0mm stacking height 60pos. under development

DF29 Advantages

♦ Performance Specifications



Current Capacity	0.3A
Rated Voltage	50V AC
Operating Temperature	-35°C to +85°C*
Contact Retention Force	1.5N Min. per pin
Contact Resistance	60 m Ω max. (100mA DC or 1000Hz)
Withstanding Voltage	150V AC, 1 minute
Insulation Resistance	500MΩ min. (100V DC)
Insertion and Withdrawal	50 times Max.

Note*: Include the temperature rising by current carrying.

Application Examples

Mobile phone, PDA, Digital Still Camera, Digital Video Camera, Bluetooth Module

Specifications herein are subject to change without notice. Contact Hirose for latest specifications, drawings or availabilities.